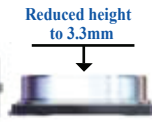
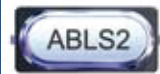


HC/49US (AT49) LOW PROFILE SURFACE MOUNT MICROPROCESSOR CRYSTAL

ABLS2



RoHS
Compliant



11.4 x 4.7 x 3.3 mm

Moisture Sensitivity Level (MSL) – This product is Hermetically Sealed and not Moisture Sensitive - MSL = N/A: Not Applicable

FEATURES:

- Suitable for RoHS compliant reflow
- Low height reduced to 3.3mm
- Available suitable for thin equipment
- Tight stability & extended temperature

APPLICATIONS:

- Computers, Modems, Microprocessors
- Wireless Applications

STANDARD SPECIFICATIONS:

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	3.579545	-----	24.00	MHz	Fundamental AT (Standard)
	24.01	-----	50.00		Fundamental AT or BT (See options)
	24.01	-----	70.00		3 rd Overtone (Standard)
Operation Mode	Fundamental or 3 rd Overtone				
Operating Temperature	0	-----	+70	°C	See options
Storage Temperature	-55	-----	+125	°C	
Frequency Tolerance @+25°C	-50	-----	+50	ppm	See options
Frequency Stability over the Operating Temperature (ref. to +25°C)	-50	-----	+50	ppm	See options (For BT cut, ±100ppm max.at -10° C to +60° C only)
Equivalent series resistance (R1)	See table 1 below			Ω	
Shunt capacitance (C0)	-----	-----	7	pF	
Load capacitance (CL)	-----	18	-----	pF	Standard (See options if other than STD)
Drive Level	-----	100	1000	μW	
Aging	-5	-----	+5	ppm	@25°C±3°C First year
Insulation Resistance	500	-----	-----	MΩ	@ 100Vdc ± 15V
Drive level dependency (DLD)	Minimum 7 points tested: from 1μW to 500μW. Change in frequency (Maximum - Minimum) over DLD range < ±10ppm Change in ESR (Maximum - Minimum) over DLD range < 25% of Max ESR value. Maximum ESR over DLD range < Max ESR value.				

TABLE 1: ESR

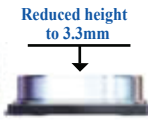
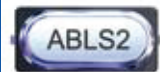
FREQUENCY (MHz)	ESR (Ω)
3.579545 - 4.999 (Fund.)	180
5.000 - 5.999 (Fund.)	120
6.000 - 7.999 (Fund.)	100
8.000 - 8.999 (Fund.)	80
9.000 - 9.999 (Fund.)	60
10.000 - 15.999 (Fund.)	50
16.000 - 50.000 (Fund.)	40
24.01 - 31.999 (3rd O/T)	100
32.000 - 70.00 (3rd O/T)	80

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11.4 x 4.7 x 3.3 mm

Options and Part Identification

(left blank if standard)

ABLS2 - MHz - - - - -

Frequency in MHz

Please specify the frequency in MHz. e.g. 14.31818MHz

Load Capacitance (pF)

Please specify CL (Minimum 10pF) in pF or S for series

Custom ESR if other than standard

R□
□: Specify a value in Ω (e.g.: R40)

Operating Temp.

A: -10°C ~ +60°C

B: -20°C ~ +70°C

C: -30°C ~ +70°C

N: -30°C ~ +85°C

D: -40°C ~ +85°C

J*: -40°C ~ +105°C

K*: -40°C ~ +125°C

L*: -55°C ~ +125°C

Freq. Tolerance

H5: ± 5 ppm

1: ± 10 ppm

7: ± 15 ppm

2: ± 20 ppm

3: ± 25 ppm

4: ± 30 ppm

Oscillation Mode

F: Fund. AT>24MHz

FB: Fund. BT>24MHz

Freq. Stability

U**: ± 10 ppm

G: ± 15 ppm

X: ± 20 ppm

W: ± 25 ppm

Y: ± 30 ppm

H: ± 35 ppm

Q: ± 100 ppm

R: ± 150 ppm

NOTE: Fundamental BT frequency stability ± 100ppm max. at -10° C to +60° C only.

* Frequency stability ±50ppm, ±100ppm, ±150ppm only. Contact ABRACON for tighter frequency stability.

** Contact ABRACON for availability of ±10ppm with other Operating Temperature options.

Diagram illustrating the reduction of the device height to 3.3 mm. The original device is shown on the left, and the reduced height version is shown on the right, with a label indicating the height reduction to 3.3 mm.

11.4 x 4.7 x 3.3 mm

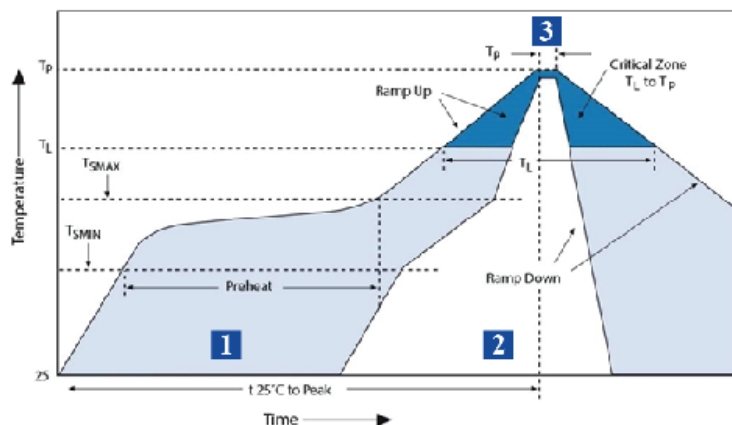
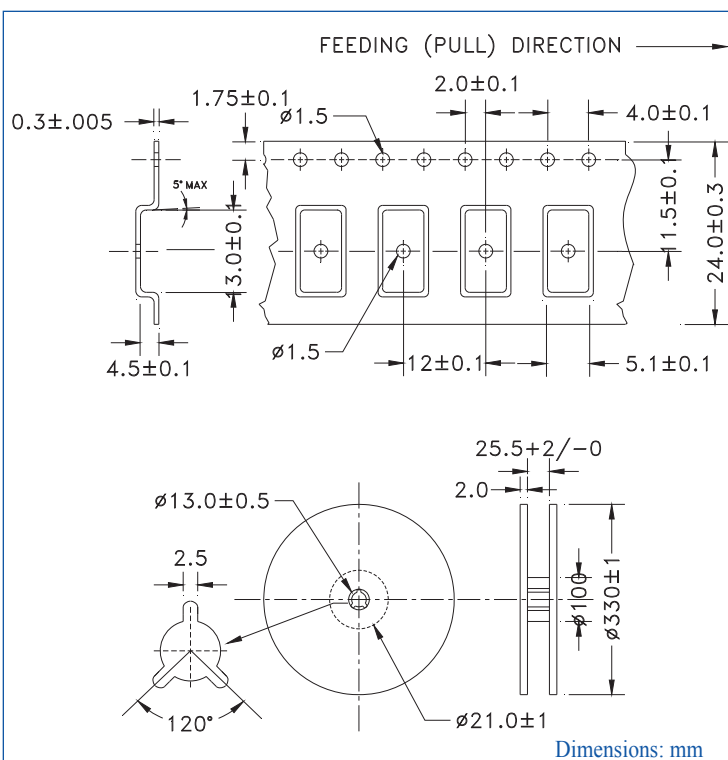


RoHS
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The technical drawing consists of three views of a rectangular component with rounded ends:

- Front View (Top):** Shows the overall dimensions. The total width is 0.500 ± 0.024 (12.7 ± 0.6). The width of the central rectangular section is 0.45 ± 0.008 (11.4 ± 0.2). The height of the component is $0.19 \pm .006$ (4.7 ± 0.15).
- Side View (Middle):** Shows the profile of the component. The maximum height of the top surface is 0.406 max. (10.3). The thickness of the base layer is 0.13 max. (3.3). The bottom surface has a tolerance of 0.004 max. , 0.000 min. (0.1 max.) (0.0 min.) on both sides.
- End View (Bottom):** Shows the cross-section of the component. The diameter of the central hole is 0.192 ± 0.008 (4.88 ± 0.2). The thickness of the component is $0.024 + .008 / - .004$ ($0.6 + 0.2 / - 0.1$).

Reflow Profile



Zone	Description	Temperature	Time
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 180°C	60 ~ 120 sec.
2	Reflow	T_r 230°C	30 ~ 40 sec.
3	Peak Heat	T_p 260°C	10 sec. MAX

ATTENTION: Abracon products are COTS - Commercial-Off-The-Shelf products; suitable for Commercial, Industrial and, where designated, Automotive Applications. Abracon's products are not specifically designed for Military, Aviation, Aerospace, Life-dependant Medical applications or any application requiring high reliability where component failure could result in loss of life and/or property. For applications requiring high reliability and/or presenting an extreme operating environment, written consent and authorization from Abracon is required. Please contact Abracon for more information.